

FINAL Report

**Grant/Contract Title: ALIGNER/BONDER FOR FABRICATION OF
NANOSCALE SPECTRAL AND POLARIMETRIC SENSORS**

By

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13. ABSTRACT (Maximum 200 words) The Center for High Technology Materials (CHTM) at the University of New Mexico had requested funds to purchase a Mask Aligner/Bond Aligner (for example, Suss-microtech MA-6/BA-6) for development of next generation sensors. The funds from this grant were used to supplement some other funds received from AFOSR and AFRL to purchase a refurbished FC-150 with a solder reflow arm. Although the PI, Prof. Krishna, worked hard to obtain as much functionality in the system, some of the options and accessories had to be traded off depending on the budget allocated. The system was installed in the PI's laboratory in May 2008 and has been functional. The first batch of successful focal plane arrays was bonded in November 2008. Since the equipment only has a solder reflow arm, the applied force is limited to only 4Newtons. This may be sufficient for some bonding experiments, but will need further training and modification to obtain a high yield focal plane array.			
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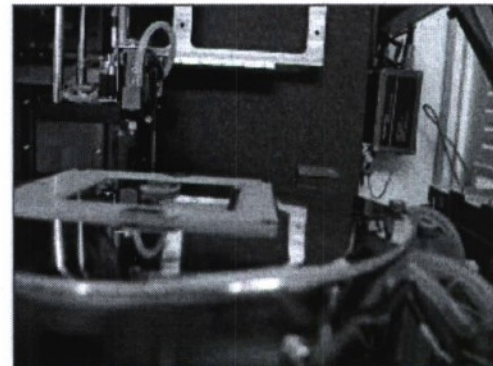
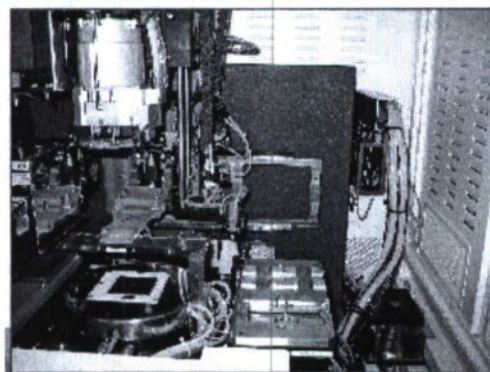
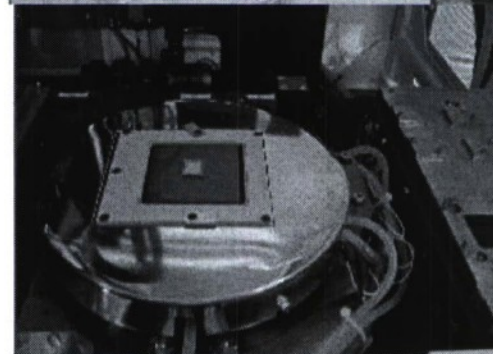
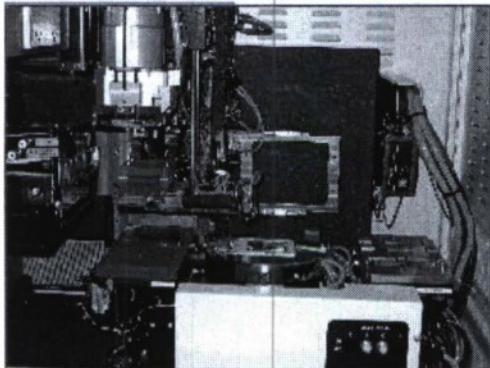
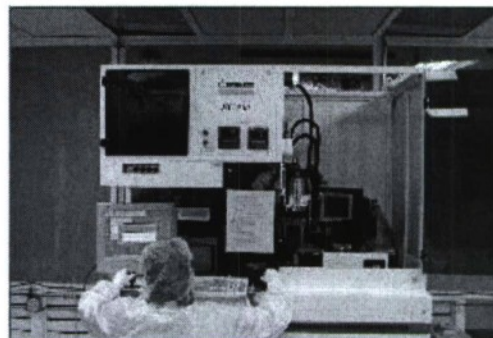
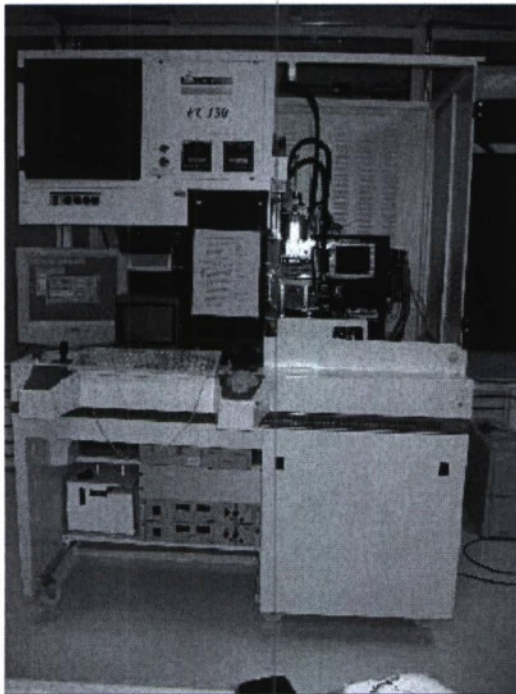
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Accomplishments

The Center for High Technology Materials (CHTM) at the University of New Mexico had requested funds to purchase a Mask Aligner/Bond Aligner (for example, Suss-microtech MA-6/BA-6) for development of next generation sensors. The funds from this grant were used to supplement some other funds received from AFOSR and AFRL to purchase a refurbished FC-150 with a solder reflow arm. Although the PI, Prof. Krishna, worked hard to obtain as much functionality in the system, some of the options and accessories had to be traded off depending on the budget allocated. The system was installed in the PI's laboratory in May 2008 and has been functional. The first batch of successful focal plane arrays was bonded in November 2008. Since the equipment only has a solder reflow arm, the applied force is limited to only 4Newtons. This may be sufficient for some bonding experiments, but will need further training and modification to obtain a high yield focal plane array.

The proposed system has various capabilities including (i) Top/ bottom side / infrared alignment, (ii) High-quality, diffraction reduction exposure optics for high resolution (+/- 0.5 mm) (iii) Room temperature to 450C direct (fusion) bonding with post bond alignment accuracies of 0.5 μm (iv) High accuracy fixture and fixtureless, (v) Ability to handle wafers from a few mm to 150 mm. This equipment will serve as a vital resource for a variety of projects at CHTM including three projects currently being undertaken by the PI. This will also serve as a community tool not only for researchers at CHTM but also for researchers all over the nation as CHTM is a part of the National Nanoscience Infrastructure Network (NNIN). Since this will be a shared resource, CHTM/UNM has supported the cost associated with installation and allocation of clean room space for the equipment for no additional cost to the program. Pictures of the system (Suss-Microtech MA-6/BA-6) installed in the PI's laboratory are shown below.



Images of the installed FC-150 Solder Reflow Arm (SRA) FC-150 Hybridizer in the PI's laboratory at the Center for High Technology Materials at the University of New Mexico.

Research and Research-Related Education

The purchase of the proposed system will greatly compliment the efforts being pursued at the Air Force Research Laboratory (AFRL). The PI, Prof. Krishna, works very closely with researchers at AFRL/VSSS (Dr. Dave Cardimona's group) and the proposed system will further bolster the collaborative efforts. One student, Ms. Diana Maestas, graduated with an M.S. from the PI's group and is presently working with AFRL/VSSS. Another student, Ms. Casey Rhodes, is presently working at AFRL/VSSS and is undertaking her M.S. under the PI's supervision.